

MCNI8596-P47 X-Band Internally Matched GaN Device

Key Features

■ Operating Frequency: 8.50-9.60 GHz
 ■ Saturated Output Power (Psat): ≥ 47 dBm

Power Gain(Gp): ≥ 8 dB
 Work Efficiency (η): ≥ 36%
 Port Matching: Zin/Zout = 50 Ω



Product Description

The MCNI8596-P47 is an internal matching GaN device, which adopts advanced co-planar internal matching MCM and thin film circuit technology. The typical working frequency range is 8.50-9.60GHz.

This device can be used in different RF/Microwave system and subsystem. The high output power level, high efficiency and wide operating temperature range can make application very flexible.

Absolute Maximum Ratings (Tc=25°C)

Parameter	Symbol	Value	Unit	
Drain-Source Voltage	V _{DS}	40	V	
Gate-Source Voltage	V _{GS}	-5	V	
Storage Temperature	T _{stg}	-65 ~ +150	°C	
Channel Temperature	Tch	150	°C	

^{*}Not recommended to work under these conditions.

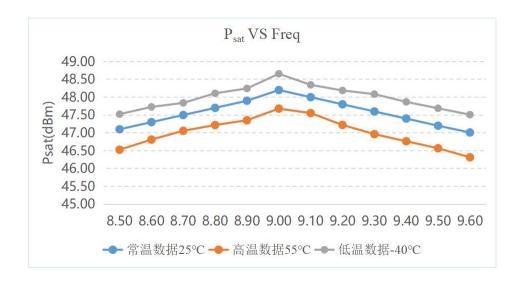
Microwave Electrical Characteristics

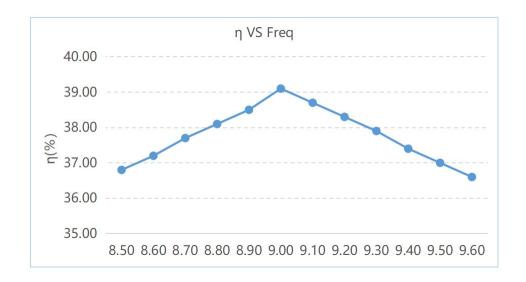
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Drain Current	dsr	VDS:28V CW Pin: 39dBm Freq: 8.5~9.6GHZ	-	5	-	Α
Saturated Output Power	P _{sat}		47	-	-	dBm
Power Gain	G _p		8	-	-	dB
Work Efficiency	η		36	-	-	%
Gain Flatness	ΔG		-0.8	-	0.8	dB

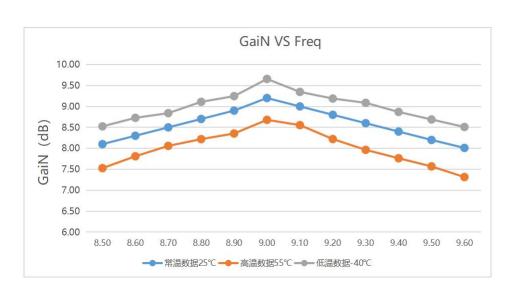


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Typical Curves





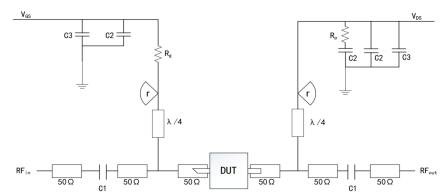




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Recommended Application Circuit



DUT: Device Under Test

C1:1pF Rp:51 Ω C2:1000pF Rg:15 Ω

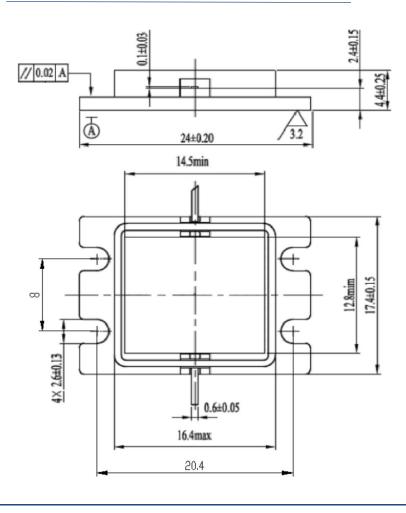
C3:100uF

Radius ≈ 3.5mm (Rogers 5880, 20 mil)

ESD Level

ESD Class III 2000V

Overall Dimensions



Using Notes:

- During transportation and storage, ensure proper drying.
- During the use and assembly of the chip, take precautions against static electricity. Wear a grounded anti-static wristband.
- When powering on, apply gate voltage first, then apply leakage voltage.

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